a) What is the size of the memory array? (How many different words are stored in the memory array? What is the word size constructed from the four 32x4 SRAM devices?)

b) What is the address space for each of the four 32x4b SRAM devices? (What are the starting and ending addresses for each of the 32x4b SRAM devices?)
Given the sequential circuit above with the state variables $A$ and $B$, externally applied input $x$ and output $f$. Answer the questions for parts a and b below.

a) Fill in the missing values for the state table. **Show all relationships** used to fill in the state table values for full credit.

<table>
<thead>
<tr>
<th>Present Input</th>
<th>Present State</th>
<th>Present Output</th>
<th>Next State</th>
<th>D Flip Flop Inputs</th>
<th>SR Flip Flop Inputs</th>
</tr>
</thead>
<tbody>
<tr>
<td>$x$</td>
<td>$A$</td>
<td>$B$</td>
<td>$f$</td>
<td>$A^*$</td>
<td>$B^*$</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>0</td>
<td>0</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>0</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>1</td>
</tr>
<tr>
<td>0</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>1</td>
<td>0</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>0</td>
<td>0</td>
<td>0</td>
<td>0</td>
</tr>
<tr>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
<td>1</td>
</tr>
</tbody>
</table>

b) Using the state table from part a, draw the state transition diagram and use it to explain if the circuit has predictable behavior.
Implement the function $F(A, B, C, D) = \prod M(0, 2, 4, 7, 9, 10, 13, 14, 15)$ using:

a) Two 3:8 decoders with active-high enable signals

b) One 8:1 multiplexer

c) One 4:1 multiplexer
Answer the following questions.

a) Draw the AND-OR Programmable Logic Array (PLA) for the following function: \( F(A, B, C) = \prod M(0, 1, 3, 5) \)

b) Draw the OR-AND PLA for the following function: \( G(A, B, C) = \Sigma m(2, 4, 5, 7) \)

c) You are designing a FSM to keep track of the mood of four students working in the digital design lab. Each student's mood is either HAPPY (the circuit works), SAD (the circuit blew up), BUSY (working on the circuit), CLUELESS (confused about the circuit), or ASLEEP (face down on the circuit board). How many states does the FSM have? What is the minimum number of bits necessary to represent these states?
In the magnetic structure drawn below (not to scale), the lower half is fixed and the upper half is constrained to move in the $x$ direction only. The permeability of the structure is infinite, and the depth into the page is 15 mm.

a. Sketch the magnetic equivalent circuit.

b. Solve for flux linkage in the coil.

c. Find the co-energy.

d. Find the force acting to close the air gaps.
A three-phase, round-rotor synchronous generator is connected to a 4160 V, 60 Hz bus. The synchronous reactance is 3.5 Ω. It is generating 1.0 MW and delivering 500 kVAR to the bus.

a. Setting phase a line-to-neutral voltage $\hat{V}_a$ as your angle reference, find $\hat{I}_a$.

b. Determine $E_a$ and $\delta$.

c. Without changing field current, what is the maximum active (real) power that the generator can deliver? What is the reactive power flow in this condition?
We have a 3-phase system with a single line diagram shown below (the transformer is Y-Y). If $V_1=100$, 1. what is the load current $i_3$, 2. what is the source current $i_1$, and 3. what is the total active and reactive power supplied by the source? (Ignore $C$ for all of these items).

Assume that a capacitor $C$ is connected as shown below to compensate for the reactive power of the source. If a source power factor of 1 (unity) is of interest, 4. what is the proper value for capacitor $C$?
For the following system, 1. Form the Y matrix, 2. If the Gauss Seidel method is

\[ V_i^{j+1} = \frac{1}{Y_{ii}} \left[ \frac{S_i^*}{V_i^j} - \sum_{k=1, k \neq i}^N Y_{ik} V_k^j \right] \]

Then, perform 2 iterations of Gauss-Seidel to find the voltage of bus 2. Start from 1+0j.
Determine the Thévenin equivalent of the following circuit when the left-side network to nodes $c$ and $d$ is to be replaced with an equivalent Thévenin voltage and a Thévenin resistance. The right-side network is the load resistance of 10 ohms.
Find the steady-state current, \( i(t) \), in the following circuit.

\[ 60 \sin(50t) \text{ V} \]

\[ 4 \cos(100t+45^\circ) \text{ A} \]
Current density $\vec{J} = J_0 r^2$ (A/m²) exists in an infinitely-long conductor of radius "a" as shown below. Show your work for full credit.

a. Find the total current in the conductor.
b. Find the magnetic field, $\vec{H}$, everywhere.
c. There are three directions one can move the rectangular loop shown below: radially outward (i.e., along the y-axis), up or down (along the z-axis), or around the conductor (in the $\hat{\phi}$ direction). For each of these three direction, will there be an induced voltage? Explain.
For the lossless transmission line system with a characteristic impedance $Z_0$ shown below, find $Z_{in}$ when the load impedance is: (a) $Z_L = \infty$ and (b) $Z_L = 0$. 

![Diagram of transmission line system with $\lambda/4$ sections and impedances $Z_0$, $2Z_0$, and $Z_L$.]
Consider a silicon (Si: a Col. IV material) abrupt-junction pn diode in which only donors are on the n-side and only acceptors are on the p-side.  \( T = 300 \text{ K} \). Important physical constants are:

- Boltzmann's constant: \( k = 1.38 \times 10^{-23} \text{ J/K} = 8.62 \times 10^{-5} \text{ eV/K} \)
- Planck's constant: \( h = 4.14 \times 10^{-15} \text{ eV-s} \)
- Carrier Mobilities: \( \mu_n = 1350 \text{ cm}^2/\text{V-s} \) \( \mu_p = 480 \text{ cm}^2/\text{V-s} \)
- Bandgap Energy of Si: \( E_g = 1.11 \text{ eV} \)
- Intrinsic Concentration: \( n_i = 1.50 \times 10^{10} \text{ cm}^{-3} \) at 300 K

(a) Silicon (Si) is a column IV material on the periodic table and it is in the third row. Neon (Ne) is a column VIII material on the periodic table and it is at the end of the second row. If the electronic configuration for Neon is \( 1s^2 2s^2 p^6 \), state the electronic configuration for Silicon.

(b) The dopants are gallium (Ga: a Col. III material) and arsenic (As: a Col. V material).

Select which dopant is on the n- and p-sides of the junction.

- n-side: Ga
- p-side: Ga
- As

(circle one)

(c) The contact potential at 300 K is \( V_o = 0.70 \text{ V} \). Calculate the doping concentrations for the p and n sides if the doping concentrations on each side are equal.

(d) Let the turn-on voltage be \( V_{to} = 0.70 \text{ V} \), the reverse saturation current be 0.50 mA, and the breakdown voltage be \(-10 \text{ V}\) in the characteristic below. Calculate the current extremes if \( R = 2,000 \text{ \Omega} \) and \( V_s = +15 \text{ sin}(10t) \text{ V} \). Sketch the load lines for these extremes on the IV plot.
A set of symbols $S = \{a, b, c, d, e\}$ is found in a discrete source with the probability of occurrence being $P = \{0.1, 0.15, 0.30, 0.16, 0.29\}$.

1. What is the self-information of each symbol?

2. What is the entropy of the discrete source?

3. Use Huffman Coding to encode the symbols.

4. Compute the average coding length of the resulting Huffman code and compare it with the entropy.